



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

WARREN M. FARNWORTH
SALMAN AKRAM

Serial No.: 09/844,532

EXAMINER: Chang, R.

Filing Date: April 30, 2001

Art Unit: 3729

For: METHOD FOR FABRICATING A TEST
INTERCONNECT FOR BUMPED SEMICONDUCTOR
COMPONENTS BY FORMING RECESSES AND
CANTILEVERED LEADS ON A SUBSTRATE
(AS AMENDED)

Attorney Docket No. 97-1433.1

AMENDMENT

April 30, 2004

Mail Stop Non-Fee Amendment
Commissioner For Patents
PO Box 1450
Alexandria, VA 22313-1450

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TECHNOLOGY CENTER R3700

Sir:

This Amendment is in response to the Office Action dated 02/12/2004, having a statutory period for response set to expire on 05/12/2004.